Form (Rev. 2/01) **UNITED STATES** Docket No.: 1349.1217

## COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

EQUALIZER OF SINGLE CARRIER RECEIVER FOR IMPROVING EQUALIZATION SPEED AND EQUALIZATION METHOD THEREOF the specification of which is attached hereto, unless the following box is checked:

was filed on as United States Application Number or PCT International Application Number unassigned and was amended on (if

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

l acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefit(s) under 35 U.S.C. ' 119(a)-(d) or ' 365(a)-(c) of any foreign application(s) for patent or inventor's certificate

listed below and have also identified be application on which priority is claimed.		patent or inventor's certificate having a filing da	ate before that of the
Prior Foreign Application(s)			Priority NOT Claimed
2002-51060	Republic of Korea	28/August/2002	П
(Number)	(Country)	Day/Month/Year Filed	LJ
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(Number)	(Country)	Day/Month/Year Filed	
designating the United States, listed be United States or PCT International appl disclose information which is material to application and the national or PCT Inte	low and, insofar as the subject m ication(s) in the manner provided o patentability as defined in 37 C. ernational filing date of this applic		not disclosed in the prior knowledge the duty to he filing date of the prior
(Application Serial No.)	(Filing Date)	(Status patented, pending,	, abandoned)
(Application Serial No.)	(Filing Date)	(Status patented, pending,	, abandoned)
all business in the Patent and Tradema	ork Office connected therewith:  211 PATENT TRADE	are.true and that all statements made on informa	ation and belief are
	both, under Section 1001 of Title	e knowledge that willful false statements and th 18 of the United States Code and that such will	
Inventor's Signature	Sew Hn	Date June 14, 2003	3
Residence Daegu-city, Korea	0	Citizenship Republic of Korea	
Mailing Address 3032-12, Daemyeor	ng-4-dong, Nam-qu, Daegu-city		
Full name of second inventor <u>Hae-</u>	sock OH		
Inventor's Signature	-Sock Oh	Date June 14, 200	)3
Residence <u>Daegu-city</u> , Korea		Citizenship Republic of Korea	
Mailing Address 3044-86. Daemveor	ng-4-dong, Nam-gu, Daegu-city	v. Korea	

Additional inventors are being named on separately numbered sheets attached hereto.

## **UNITED STATES**

COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION
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Docket No.: <u>1349,1217</u>

Full name of third inventor <u>Ju-yeun KIM</u>				
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Inventor's Signature <u>Ju - xeun</u> Kim	Date June 14, 2003			
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Full name of fourth inventor <u>Jung-jin KIM</u>				
Inventor's Signature Jang - In Lim	Date June 14, 2003			
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Full name of fifth inventor				
Inventor's Signature				
Residence				
Mailing Address				
Full name of sixth inventor				
Inventor's Signature	Date			
Residence				
Mailing Address				
Full name of seventh inventor				
Inventor's Signature				
Residence				
Mailing Address				
Full name of eighth inventor				
Inventor's Signature				
Residence	Citizenship			
Mailing Address				
Full name of ninth inventor				
Inventor's Signature	Date			
Residence				
Mailing Address				